



The City of Parma Andrew Boyko Memorial Scholarship Applicant Recommendation Form

Applicant Number _____

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The City of Parma Andrew Boyko Memorial Scholarship Foundation was established in 2006 in honor of Andrew Boyko, who served the City of Parma for over 30 years as judge, law director and in many other capacities. The Scholarship is intended to provide financial assistance to high school seniors from the city of Parma wishing to pursue post-secondary education. The scholarship Selection Committee will take into consideration each applicant's financial need, special circumstances, character, scholastic record, involvement in community service and commitment to the City of Parma. One of these scholarships will be designated for the applicant exhibiting an exceptional commitment to community service.

Each applicant for The City of Parma Andrew Boyko Memorial Scholarship is required to submit one applicant recommendation form. A high school teacher or counselor, member of the clergy, professional or supervisor, or another adult who can attest to the character and work ethic of the applicant must complete this form. A family member of the applicant, members of the Board of Trustees, the Selection Committee or their family members may not complete this form. **For confidentiality purposes, scholarship applications are rated in a *blind* fashion; therefore, we respectfully ask that the person providing the recommendation include only reference to the applicant's first name.** Please complete this form, sign it, attach your letter of recommendation and provide it to the applicant. All information provided will be kept confidential. Thank you for your time and assistance in this process. **DUE DATE FOR APPLICATION: APRIL 1, 2020.**

Name of Person Completing Form: _____

Title or Position: _____

Signature: _____

Full Address: _____

Phone Number: (_____) _____

E-Mail: _____

Relationship to applicant: _____